



SPN9926B

N-Channel Enhancement Mode MOSFET

DESCRIPTION

The SPN9926B is the Dual N-Channel logic enhancement mode power field effect transistors are produced using high cell density , DMOS trench technology.

This high density process is especially tailored to minimize on-state resistance.

These devices are particularly suited for low voltage application , notebook computer power management and other battery powered circuits where high-side switching .

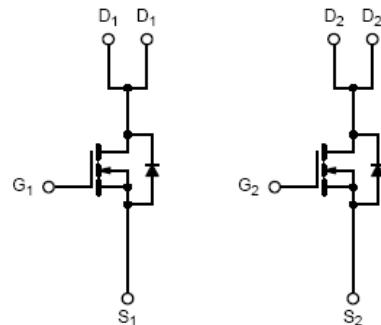
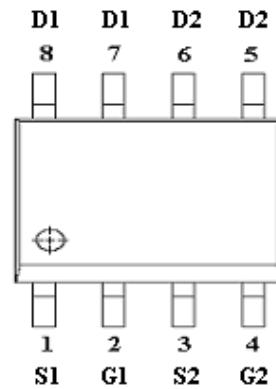
FEATURES

- ◆ 20V/6.0A,R_{DS(ON)}=33mΩ@V_{GS}=4.5V
- ◆ 20V/5.0A,R_{DS(ON)}=38mΩ@V_{GS}=2.5V
- ◆ Super high density cell design for extremely low RDS (ON)
- ◆ Exceptional on-resistance and maximum DC current capability
- ◆ SOP – 8P package design

APPLICATIONS

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC
- LCD Display inverter

PIN CONFIGURATION(SOP – 8P)



PART MARKING



A : Lot Code
B : Date Code



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PIN DESCRIPTION

Pin	Symbol	Description
1	S1	Source 1
2	G1	Gate 1
3	S2	Source 2
4	G2	Gate 2
5	D2	Drain 2
6	D2	Drain 2
7	D1	Drain 1
8	D1	Drain 1

ORDERING INFORMATION

Part Number	Package	Part Marking
SPN9926BS8RGB	SOP- 8P	SPN9926B

※ SPN9926BS8RGB : 13" Tape Reel ; Pb – Free ; Halogen – Free

ABSOLUTE MAXIMUM RATINGS

(TA=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V _{DSS}	20	V
Gate –Source Voltage	V _{GSS}	±12	V
Continuous Drain Current(T _J =150°C)	T _A =25°C	ID	A
	T _A =70°C		
Pulsed Drain Current	I _{DM}	30	A
Continuous Source Current(Diode Conduction)	I _S	1.6	A
Power Dissipation	T _A =25°C	P _D	W
	T _A =70°C		
Operating Junction Temperature	T _J	-55/150	°C
Storage Temperature Range	T _{STG}	-55/150	°C
Thermal Resistance-Junction to Ambient	R _{θJA}	105	°C/W



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ELECTRICAL CHARACTERISTICS

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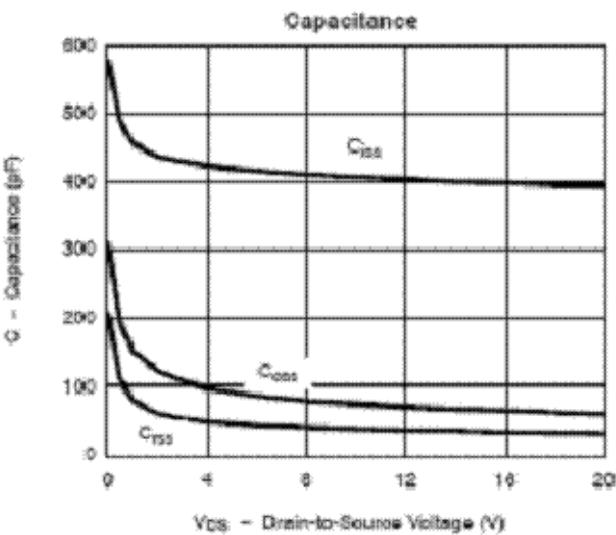
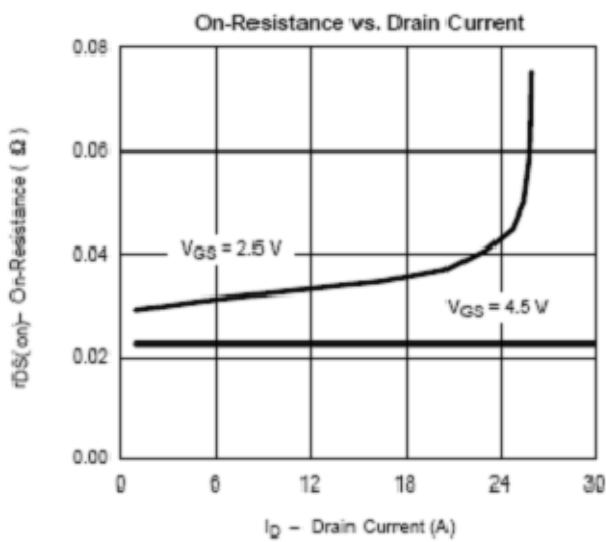
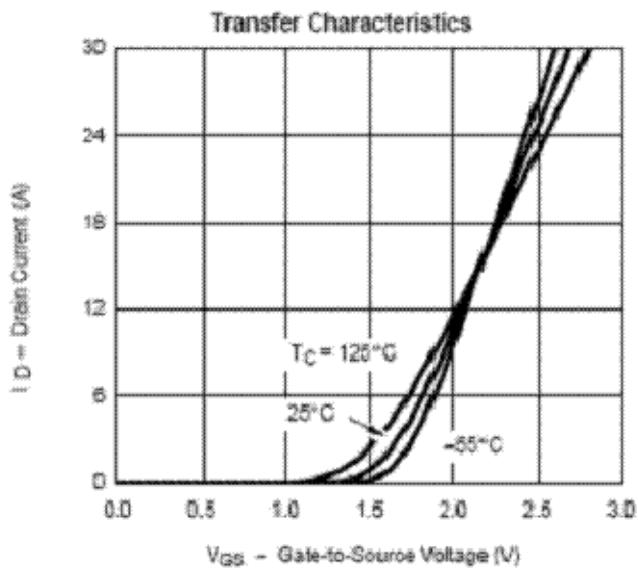
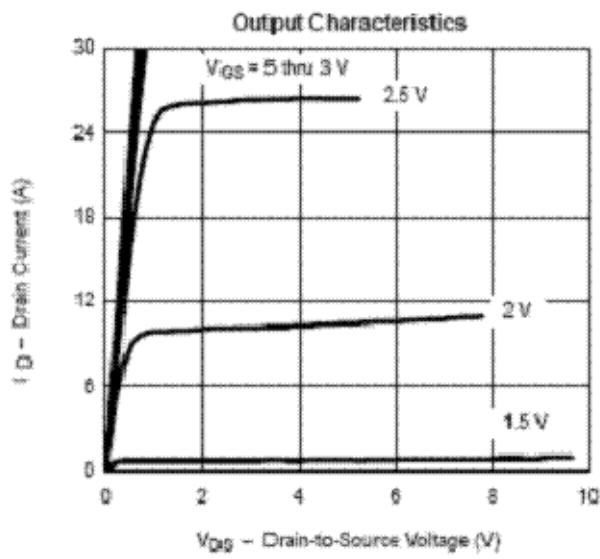
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V(BR)DSS	VGS=0V, ID=250uA	20			V
Gate Threshold Voltage	VGS(th)	VDS=VGS, ID=250uA	0.5		1.0	
Gate Leakage Current	IGSS	VDS=0V, VGS=±12V			±100	nA
Zero Gate Voltage Drain Current	IDSS	VDS=20V, VGS=0V			1	uA
		VDS=20V, VGS=0V TJ=55°C			5	
On-State Drain Current	ID(on)	VDS≤5V, VGS=4.5V	6			A
Drain-Source On-Resistance	RDS(on)	VGS=4.5V, ID=6.0A		0.028	0.033	Ω
		VGS=2.5V, ID=5.0A		0.032	0.038	
Forward Transconductance	gfs	VDS=5V, ID=-3.6A		10		S
Diode Forward Voltage	VSD	IS=1.7A, VGS=0V		0.8	1.2	V
Dynamic						
Total Gate Charge	Qg	VDS=10V, VGS=4.5V, ID=6.0A		2		nC
Gate-Source Charge	Qgs			2.5		
Gate-Drain Charge	Qgd			2.1		
Input Capacitance	Ciss	VDS=8V, VGS=0V f=1MHz		575		pF
Output Capacitance	Coss			84		
Reverse Transfer Capacitance	Crss			22		
Turn-On Time	td(on)	VDD=10V, RL=6Ω ID=1.0A, VGEN=4.5V RG=6Ω		10	14	ns
	tr			16	20	
Turn-Off Time	td(off)			35	40	
	tf			3	10	



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TYPICAL CHARACTERISTICS

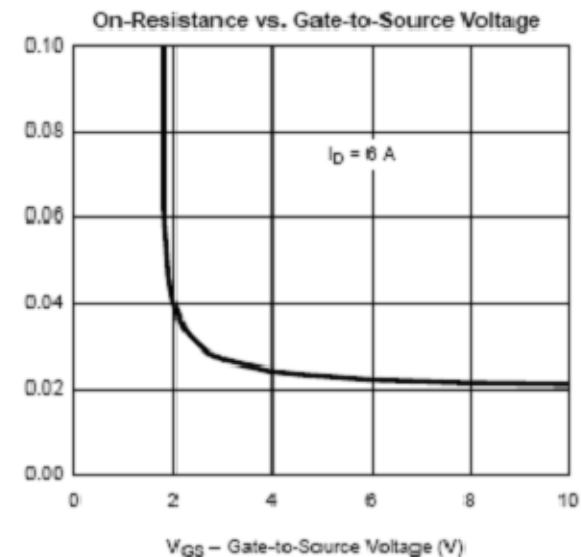
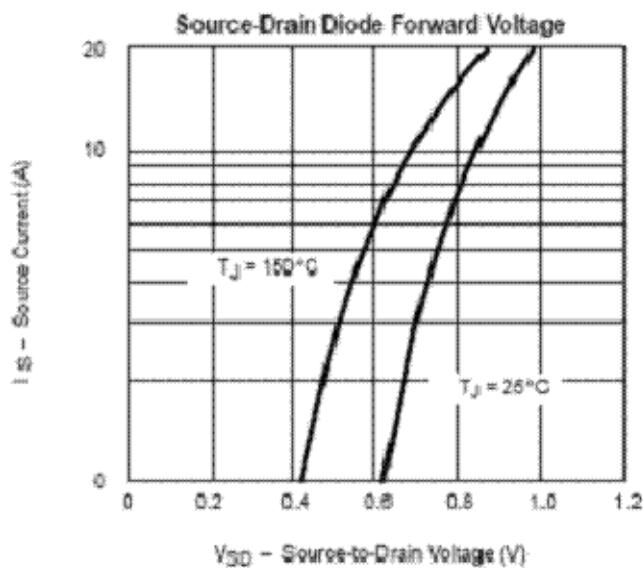
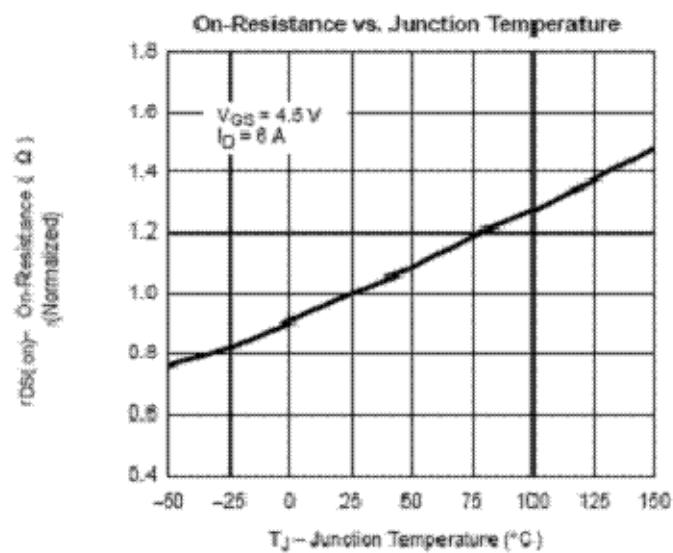
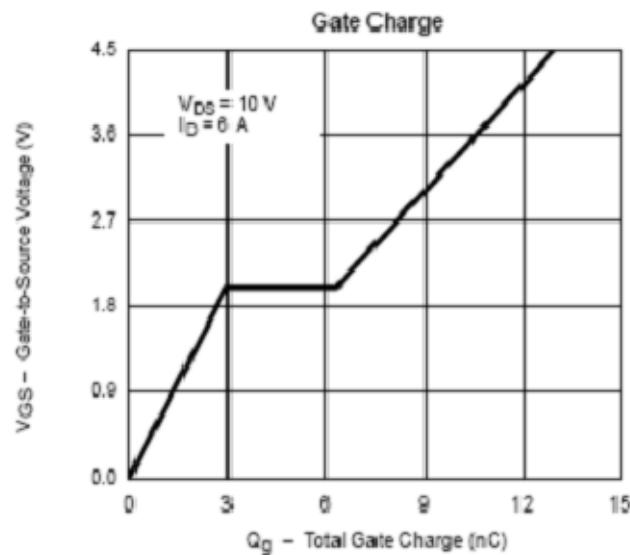




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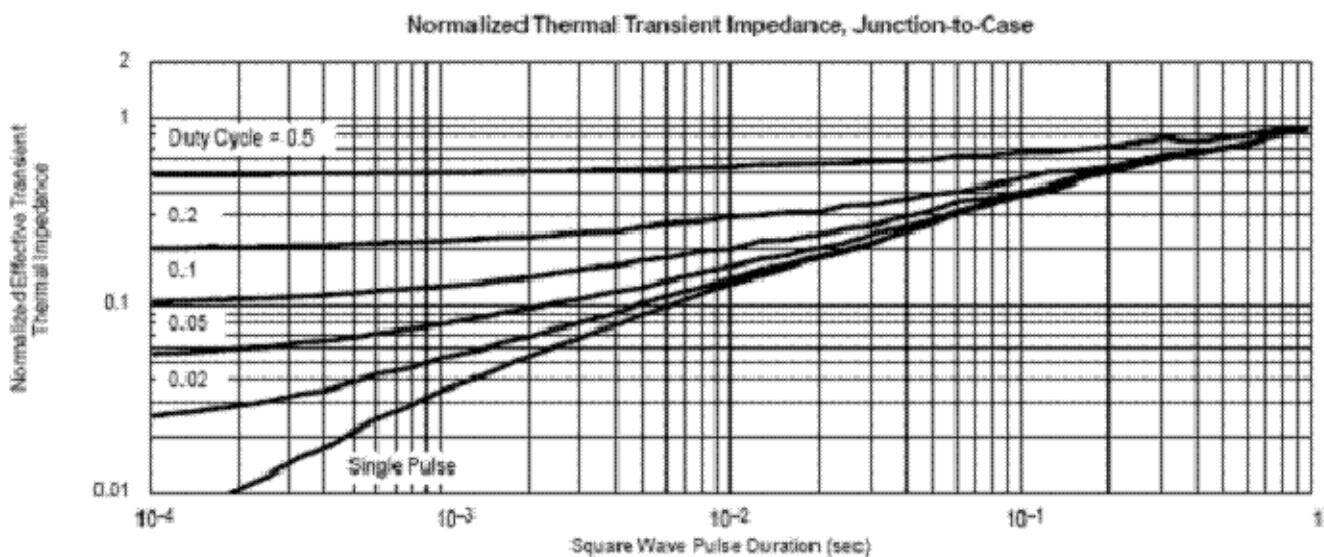
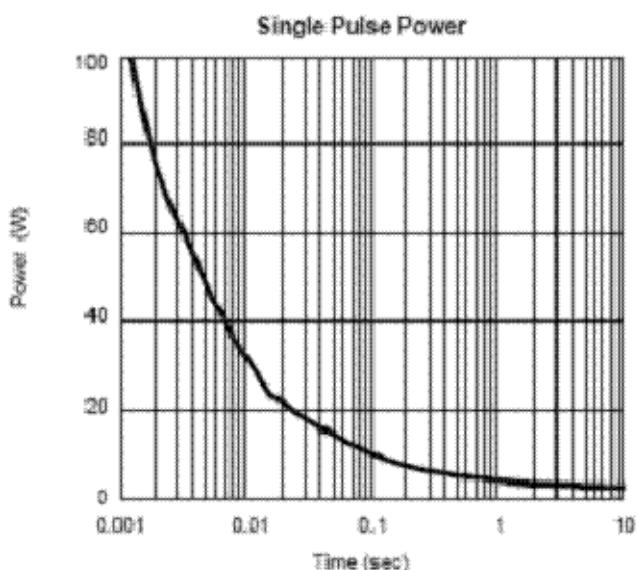
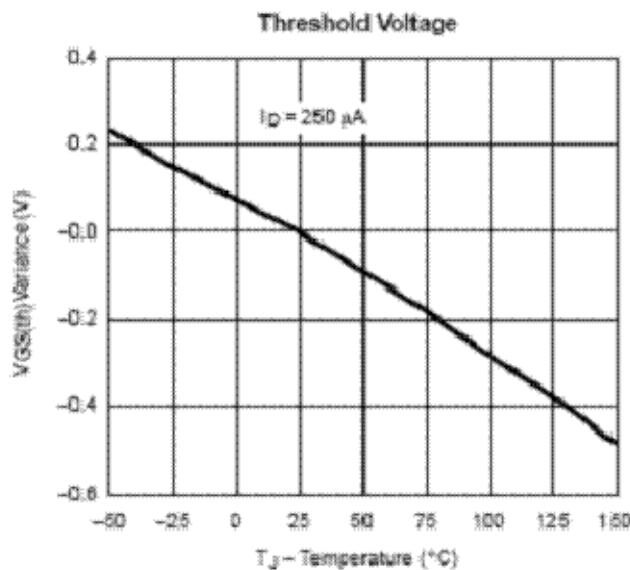




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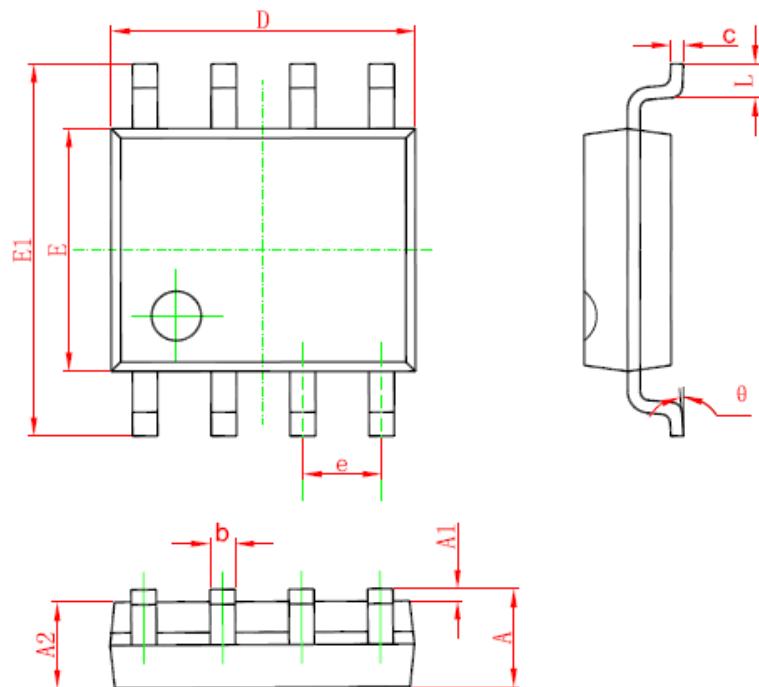




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SOP-8 PACKAGE OUTLINE



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270(BSC)		0.050(BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°



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SYNC Power Corporation

7F-2, No.3-1, Park Street

NanKang District (NKSP), Taipei, Taiwan 115

Phone: 886-2-2655-8178

Fax: 886-2-2655-8468

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